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# Design and Applications of Additive Manufacturing and 3D Printing

Guest Editor:

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Deadline for manuscript submissions:

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## **Message from the Guest Editor**

Dear Colleagues,

The additive manufacturing (AM) business has grown in double digits in past years. The development of new materials and equipment has opened up new application possibilities, and equipment is quicker and cheaper using the new materials launched by vendors and material developers. AM has become more important for industry, but also for academics. Since AM offers more design freedom than any other manufacturing process, it provides designers with a new challenge to design better and more efficient products.

- Design for additive manufacturing
- Industrial applications of additive manufacturing
- Medical applications of additive manufacturing
- AM materials and equipment development
- AM processes
- Topology optimization

The objective of this Special Issue is to provide a forum for researchers and practitioners to exchange their latest achievements and to identify critical issues and challenges for future investigations of the design and applications of additive manufacturing.

Dr. Mika Salmi Guest Editor



Specialsue





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## Message from the Editor-in-Chief

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